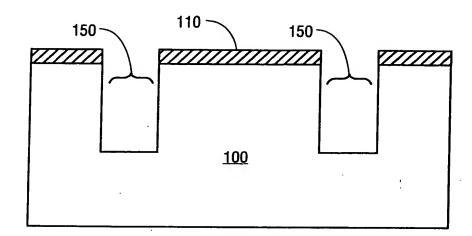
Blakely, Sokoloff, Taylor & Zafman LLP (310) 207-3800
Title: A THERMAL CONDUCTING TRENCH IN A SEMICONDUCTOR
STRUCTURE AND METHOD FOR FORMING THE SAME
1st Named Inventor: Chunlin Liang
Express Mail No.: EV339905632US
Docket No.: 42P4214D2
Sheet: 1 of 8



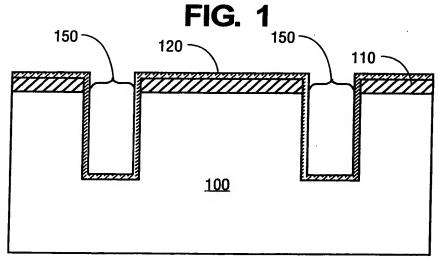


FIG. 2

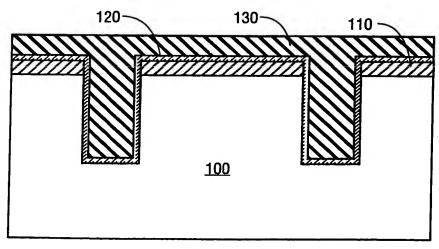


FIG. 3

1st Named Inventor: Chunlin Liang Express Mail No.: EV339905632US

Sheet: 2 of 8

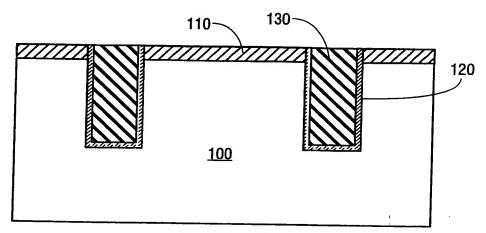


FIG. 4

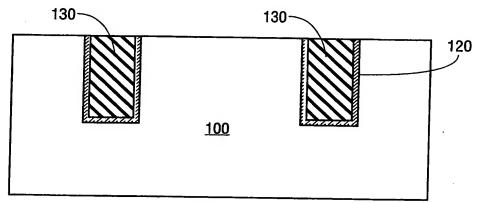


FIG. 5

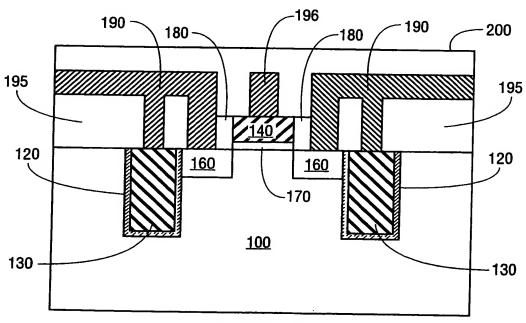


FIG. 6

Blakely, Sokoloff, Taylor & Zafman LLP (310) 207-3800
Title: A THERMAL CONDUCTING TRENCH IN A SEMICONDUCTOR
STRUCTURE AND METHOD FOR FORMING THE SAME
1st Named Inventor: Chunlin Liang
Express Mail No.: EV339905632US
Sheet: 3 of 8

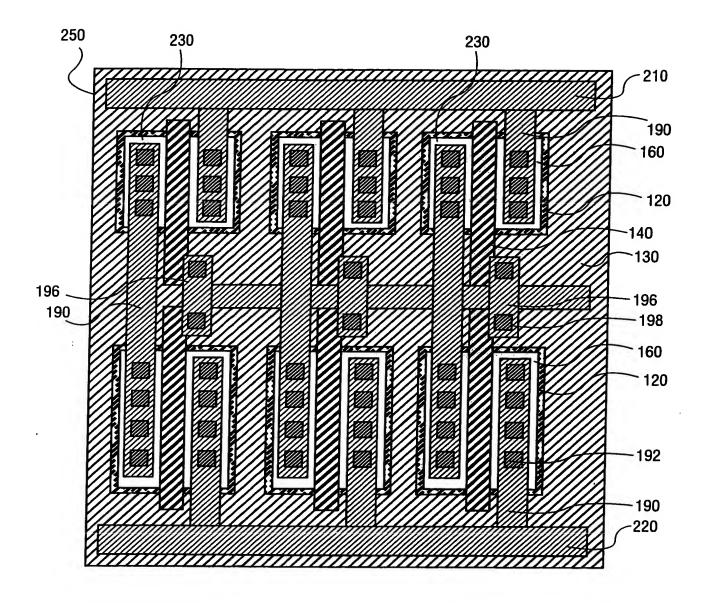


FIG. 7

Blakely, Sokoloff, Taylor & Zafman LLP (310) 207-3800
Title: A THERMAL CONDUCTING TRENCH IN A SEMICONDUCTOR
STRUCTURE AND METHOD FOR FORMING THE SAME
1st Named Inventor: Chunlin Liang
Express Mail No.: EV339905632US
Sheet: 4 of 8

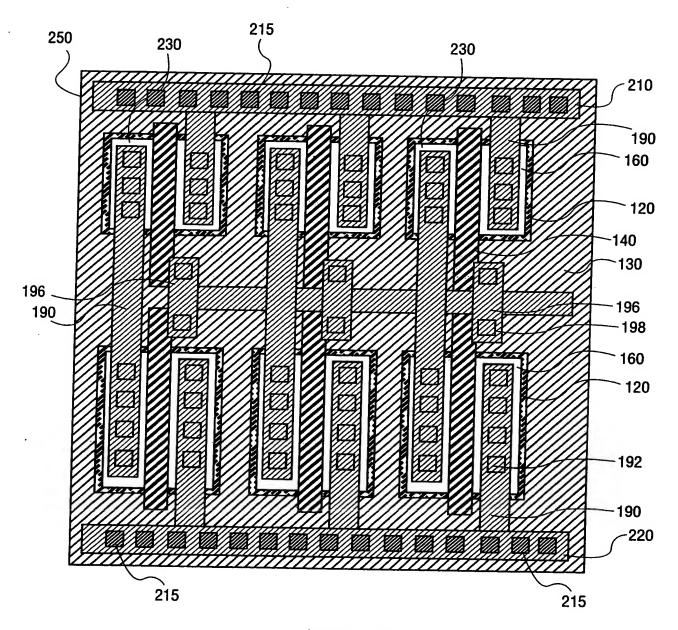


FIG. 8

1st Named Inventor: Chunlin Liang Express Mail No.: EV339905632US

Docket No.: 42P4214D2

Sheet: 5 of 8

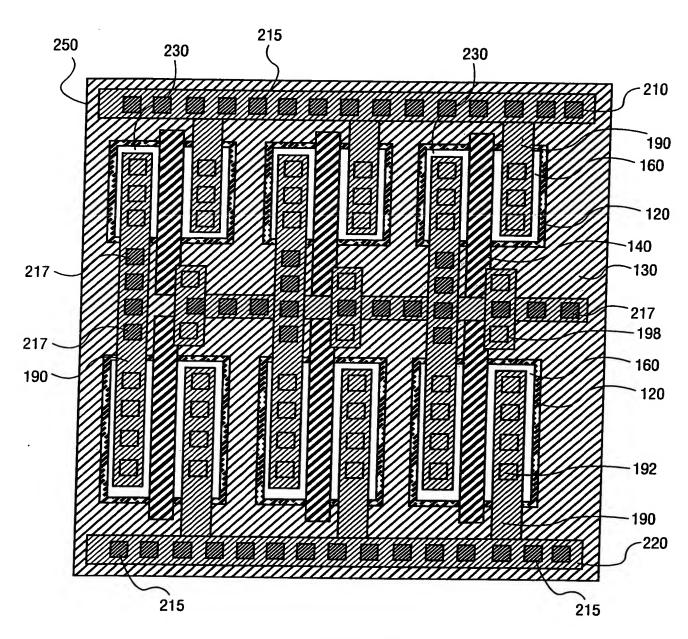
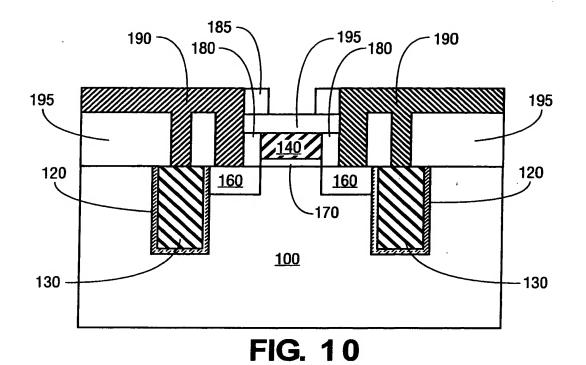
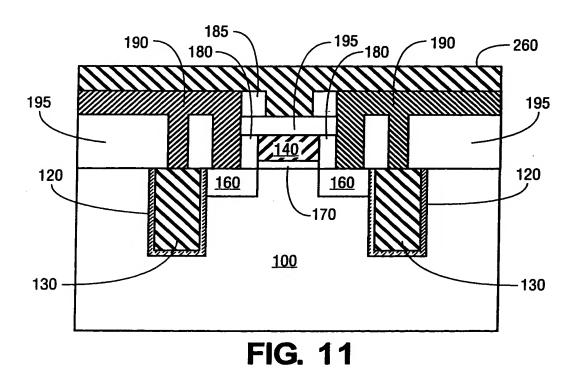


FIG. 9

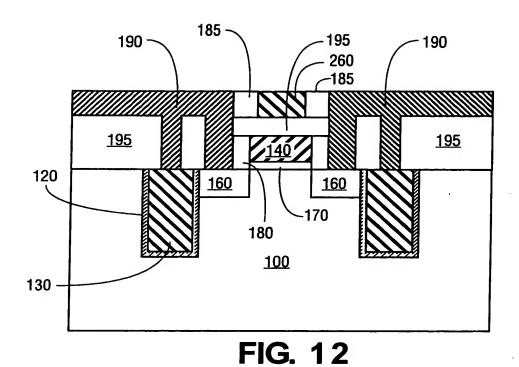
1st Named Inventor: Chunlin Liang Express Mail No.: EV339905632US

Sheet: 6 of 8





1st Named Inventor: Chunlin Liang Express Mail No.: EV339905632US Sheet: 7 of 8



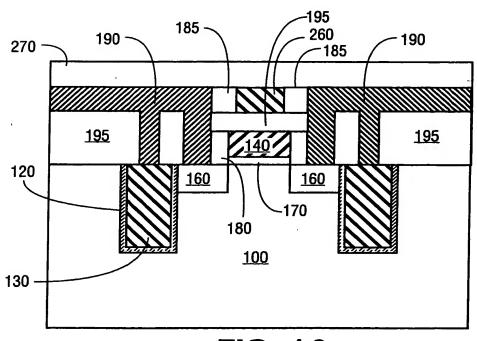


FIG. 13

1st Named Inventor: Chunlin Liang Express Mail No.: EV339905632US

Sheet: 8 of 8

